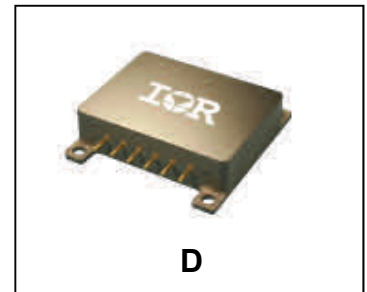


**HIGH RELIABILITY
RADIATION TOLERANT
LOW POWER
DC-DC CONVERTER****28V Input, Regulated Dual Output****Description**

The D-Series of DC-DC converters are low power radiation tolerant, high reliability devices designed for hostile radiation environments such as those encountered by geostationary earth orbit satellites, deep space probes and communication systems. Features include small size, high efficiency, low weight, and a good tolerance to total ionizing dose, single event effects, and environmental stresses such as temperature extremes, mechanical shock, and vibration. All components are fully derated to meet the requirements of EEE-INST-002 and MIL-STD-1547B. Extensive documentation including worst case analysis, radiation susceptibility, thermal analysis, stress analysis, and reliability analysis are available.

The D-Series converters have two outputs, each is independently regulated. Two versions exist; One version providing two positive outputs and one version providing one negative and one positive output. The D-Series converters incorporate a fixed frequency fly back power converter and internal EMI filter that meets the requirements for most major satellite power buses. The converters can be remotely turned on and off via an inhibit pin. Additional inhibit pins are also included to control the outputs individually. This feature facilitates turn-on outputs sequencing if desired. Each converter is encased in a cold rolled steel hermetic package. The package measures 1.80"L x 1.40"W x 0.42"H and weighs less than 55 grams. The package utilizes rugged ceramic feed-through copper pins and is hermetically sealed using parallel seam welding. Two package options are available. Please refer to page 9 for I/O configurations.

Environmental screening includes temperature cycling, constant acceleration, fine and gross leak, and burn-in as specified by MIL-PRF-38534 for class H hybrids.

Non-flight versions of the D-Series converters are available for system development purposes. Variations in electrical specifications and screening to meet custom requirements can be accommodated.

Features

- Total Dose Guaranteed to 50 kRad(Si)
- SEE with LET up to 40 MeV·cm²/mg
- Low Weight < 55 grams
- 18V to 50V DC Input Range
- Up to 10W Output Power
- Independently Regulated Outputs:
±5V, ±12V and ±15V
- -55°C to +125°C Operating Temperature Range
- 100MΩ @ 100VDC Isolation
- Input Under-Voltage Protection
- Meets Conducted Emission Requirements of Most Major Power Buses:
100Hz -100kHz: 80dBμArms
100kHz - 10MHz: Log-linear Decrease
10MHz - 50MHz: 40dBμArms
- Short Circuit and Overload Protection
- Meets the De-rating Requirements of EEE-INST-002 and MIL-STD-1547B
- Synchronization Input / Output
- On/Off Control via Converters' Inhibit Pin and Individual Output's Inhibit Pin
- High CS Damping

Applications

- Launch Vehicles
- Communication Systems
- Geostationary or Low Earth Orbit Satellites

Circuit Description

The D-Series DC-DC converters utilize two-stage regulation with a fly back topology with a switching frequency of 250kHz for primary regulation and linear post regulation in the secondary for each of the outputs

Output power is limited under any load fault condition to approximately 110% of rated output. An overload condition causes the converter output to behave like a constant current source with the output voltage dropping below nominal. The converter will resume normal operation when the load current is reduced below the current limit point.

This protects the converter from both overload and short circuit conditions. There are no latching elements to eliminate the possibility of falsely triggering the protection circuits during single event radiation exposure.

An under-voltage protection circuit prohibits the converter from operating when the line voltage is too low for safe operation. The converter will not start until the line voltage rises to approximately 16V.

An inhibit pin is provided to control converter operation. This inhibit pin is intended for operation with an open collector transistor drive or a relay closure to the input return. The pin may be left open for normal operation and has a nominal open circuit voltage of 4V. Also provided are the individual output on/off control pins (Pin 10-Output 1 Inhibit and Pin 9-Output 2 Inhibit).

Synchronization input pin is included allowing multiple converters to operate at a common switching frequency. Converters can be synchronized to a common frequency with an external clock. This may be used to eliminate beat frequency noise or to avoid generating noise at certain frequencies for noise sensitive systems.

Design Methodology

The D-Series is developed using a proven conservative design methodology, which includes selecting radiation tolerant and established reliability components and fully derating to the requirements of EEE-INST-002 and MIL-STD-1547B. Heavy derating of the radiation-hardened power MOSFET virtually eliminates the possibility of SEGR and SEB.

Specifications

Absolute Maximum Ratings		Recommended Operating Conditions	
Input Voltage range	-0.5V _{DC} to +60V _{DC}	Input Voltage range (Note 13)	18V _{DC} to 50V _{DC}
Output power	Internally limited	Output power	0 to Max. Rated
Lead Temperature	+300°C for 10 seconds	Operating temperature	-55°C to +125°C
Operating Case temperature (Note 12)	-55°C to +125°C	Operating temperature	-55°C to +73°C
Storage temperature	-55°C to +135°C	De-rated (Note 13)	

Electrical Performance Characteristics

Parameter	Group A Subgroup	Conditions -55°C ≤ T _C ≤ +85°C V _{IN} = 28V DC ± 5%, C _L = 0 unless otherwise specified	Limits			Unit
			Min	Nom	Max	
Input voltage (V _{IN})			18	28	50	V
Output voltage (V _{OUT}) D2805D D2812D D2815D	1 1 1	I _{OUT} = 100% rated load Note 4	±4.95 ±11.88 ±14.85	±5.00 ±12.00 ±15.00	±5.05 ±12.12 ±15.15	V
D2805D D2812D D2815D	2,3 2,3 2,3	I _{OUT} = 100% rated load Note 4, 14	±4.85 ±11.64 ±14.70		±5.15 ±12.36 ±15.15	V
Output power (P _{OUT}) D2805D D2812D D2815D	1,2,3	V _{IN} = 18, 28, 50V, Note 2 Either Output	0 0 0		5.0 5.0 5.0	W
Output current (I _{OUT}) D2805D D2812D D2815D	1,2,3	V _{IN} = 18, 28, 50V, Note 2 Either Output	0 0 0		1.00 0.42 0.33	A
Line regulation (VR _{LINE})	1,2,3	V _{IN} = 18, 28, 50V I _{OUT} = 0%, 50%, 100% rated	-0.05		0.05	%
Load regulation (VR _{LOAD})	1,2,3	I _{OUT} = 0%, 50%, 100% rated V _{IN} = 18, 28, 50V	-1.0		1.0	%
Cross regulation (VR _{CROSS}) D2805D D2812D D2815D	1,2,3	V _{IN} = 18, 28, 50V, Note 1			5.0 5.0 5.0	mV
Input current (I _{IN}) D2805D D2812D D2815D	1,2,3	I _{OUT} = 0, Pin 6 open Pin 6 connected to Pin 2			35 35 35 10	mA
Switching frequency (F _S)	1,2,3	Sync. Input (Pin 4) open	225	250	275	kHz

For Notes to Electrical Performance Characteristics Table, refer to page 5

Electrical Performance Characteristics (continued)

Parameter	Group A Subgroup	Conditions -55°C ≤ T _C ≤ +85°C V _{IN} = 28V DC ± 5%, C _L = 0 unless otherwise specified	Limits			Unit
			Min	Nom	Max	
Synchronization input Frequency range Pulse high level Pulse low level Pulse transition time Pulse duty cycle	1,2,3	External clock on sync In (Pin 4), Note 1	450 2.5 -0.5 40 20		550 5.0 0.5 80	kHz V V V/μs %
Output ripple (V _{RIP}) D2805D D2812D D2815D	1,2,3	V _{IN} = 18, 28, 50V I _{OUT} = 100% rated load Note 3			20 20 20	mV p-p
Output ripple @ switch frequency D2805D D2812D D2815D	1,2,3	V _{IN} = 18, 28, 50V I _{OUT} = 100% rated load Note 1		0.5 0.5 0.5	1.0 1.0 1.0	mV rms
Efficiency (E _{FF}) D2805D D2812D D2815D	1,2,3	I _{OUT} = 100% rated load	55 61 62	58 64 65		%
Inhibit input Open circuit voltage Drive current (sink) Voltage range		Note 1			4.0 600 50	V μA V
Current limit point D2805D D2812D D2815D	1,2,3	V _{OUT} = 90% of Nominal Note 10	105 105 105		145 145 145	%
Power dissipation load fault (P _D)	1,2,3	Short Circuit, Overload, Note 5			8.0	W
Output response to step load changes (V _{TLD}) D2805D D2812D D2815D	4,5,6	Half Load to/ from Full Load, Note 6	-15 -15 -15		15 15 15	mVpk
Recovery time, step load changes (T _{TLD}) D2805D D2812D D2815D	4,5,6	Half Load to/from Full Load, Notes 6, 7			500 500 500	μs
Recovery time, step line changes (T _{TLN})	4,5,6	18V to/from 50V I _{OUT} = 100% rated load, Notes 1, 7, 8			100	μs

For Notes to Electrical Performance Characteristics Table, refer to page 5

Electrical Performance Characteristics (continued)

Parameter	Group A Subgroup	Conditions -55°C ≤ T _C ≤ +85°C V _{IN} = 28V DC ± 5%, C _L = 0 unless otherwise specified	Limits			Unit
			Min	Nom	Max	
Capacitive load (C _L) D2805D D2812D D2815D	1	I _{OUT} = 100% rated load No effect on DC performance Notes 1, 4 Each output			220 33 33	μF
Turn-on response overshoot (V _{OS}) D2805D D2812D D2815D	4,5,6	10% Load, Full Load Note 9			25 25 25	mV
Turn-on delay (T _{DLY})					10	ms
Enable input (Inhibit) open circuit voltage Drive current (sink) Voltage range	1,2,3	Note 1	0		10 100 0.4	V μA V
EMC conducted susceptibility (Line rejection)	1	I _{OUT} = 100% rated load Primary power sine wave injection of 2Vp-p, 100Hz to 50MHz, Note 1	80	90		dB
Electromagnetic Interference (EMI), conducted emission (CE)	1	I _{OUT} = 100% rated load, Note 1	Limits per Fig. 1			
Isolation	1	Input to Output or Any Pin to Case except Pin 3, test @ 100 VDC	100			MΩ
Device Weight					55	g
MTBF		MIL-HDBK-217F2, SF, 35°C	100.000			Hours

Notes: Specification and Electrical Performance Characteristics

- Parameter is tested as part of design characterization or after design changes. Thereafter, parameter shall be guaranteed to the limits specified.
- Parameter verified during line and load regulation tests.
- Guaranteed for a D.C. to 20MHz bandwidth. Tested using a 20kHz to 10MHz bandwidth.
- Capacitive load may be any value from 0 to the maximum limit without compromising dc performance. A capacitive load in excess of the maximum limit may interfere with the proper operation of the converter's overload protection, causing erratic behavior during turn-on.
- Overload power dissipation is defined as the device power dissipation with the load set such that V_{OUT} = 90% of nominal.
- Load step transition time ≥ 100 μs
- Recovery time is measured from the initiation of the transient to where V_{OUT} has returned to within ±1% of its steady state value.
- Line step transition time ≥ 100 μs
- Turn-on delay time from either a step application of input power or a logic low to a logic high transition on the inhibit pin (pin 6) to the point where V_{OUT} = 90% of nominal.
- Current limit point expressed as a percentage of full rated load current
- For models with two positive outputs the envelope specification for the design is that each output voltage is limited to the range 1V to 5V.
- Although operation at temperatures between +85°C and +125°C is guaranteed, no parameter limits are specified
- Meets the de-rating requirements of EEE-INST-002 and MIL-STD-1547B – except for ceramic capacitors with voltage stress below 10V will minimum be rated at 50V.
- End of life is ± 3%

Device Screening

Test/Inspection	Method	/EM Suffix ①	Flight (No suffix)
Element Evaluation	MIL-PRF-38534 class H equivalent with SEM		X
Nondestructive Bond Pull	MIL-STD-883, Method 2023		X
Internal Visual	MIL-STD-883, Method 2017		X
Temperature Cycling	MIL-STD-883, Method 1010		Condition C
Constant Acceleration	MIL-STD-883, Method 2001 (3Kg)		A, Y1 Axis only
Electrical	In accordance with device specification		X
PIND	MIL-STD-883, Method 2020		A
Burn-in (2 × 160 hours)	MIL-STD-883, Method 1015	48 hours	320 hours
Final Electrical (Group A)	In accordance with device specification	X	X
Seal Fine Leak Gross Leak	MIL-STD-883, Method 1014	Condition A	A1 C
Radiographic	MIL-STD-883, Method 2012		N/A
External Visual	MIL-STD-883, Method 2009	X	X

Notes:

- ① Any Engineering Model (EM) build with the “EM” Suffix shall only be form, fit and functional equivalent to its Flight Model (FM) counterpart, and it may not meet the radiation performance. The EM Model shall not be expected comply with MIL-PRF-38534 flight quality/workmanship standards, and configuration control. An EM build may use electrical equivalent commercial grade components. IR HiRel will provide a list of non-compliance items upon request.

Radiation Performance Characteristics

Test	Conditions	Min	Unit
Total Ionizing Dose (Gamma)*	MIL-STD-883, Method 1019.5 Operating bias applied during exposure, Full Rated Load, $V_{IN} = 28V$	50	kRads(Si)
Single Event Effects* SEU, SEL, SEGR, SEB	Heavy ions (LET) Operating bias applied during exposure, Full Rated Load, $V_{IN} = 18, 28, 50V$	40	MeV·cm ² /mg

* Test performed at TAMU

IR HiRel currently does not have a DLA certified Radiation Hardness Assurance Program.

Fig. 1 – EMI conducted emission Performance Limit

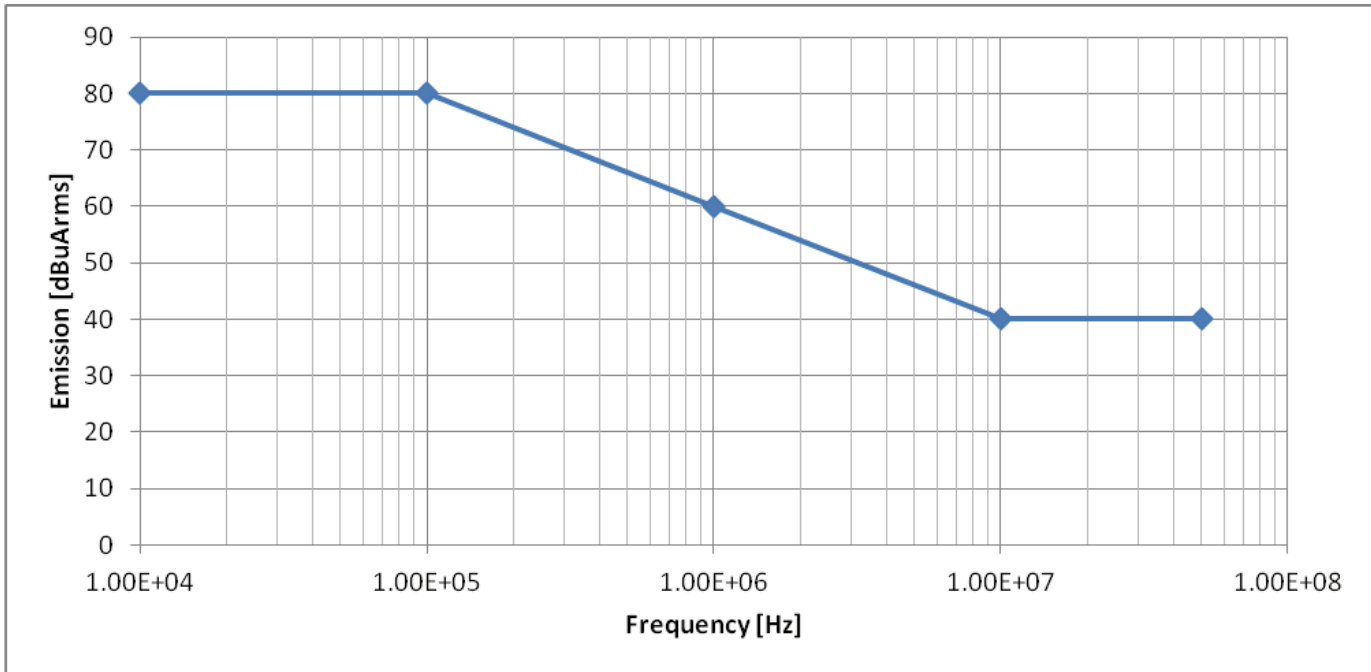
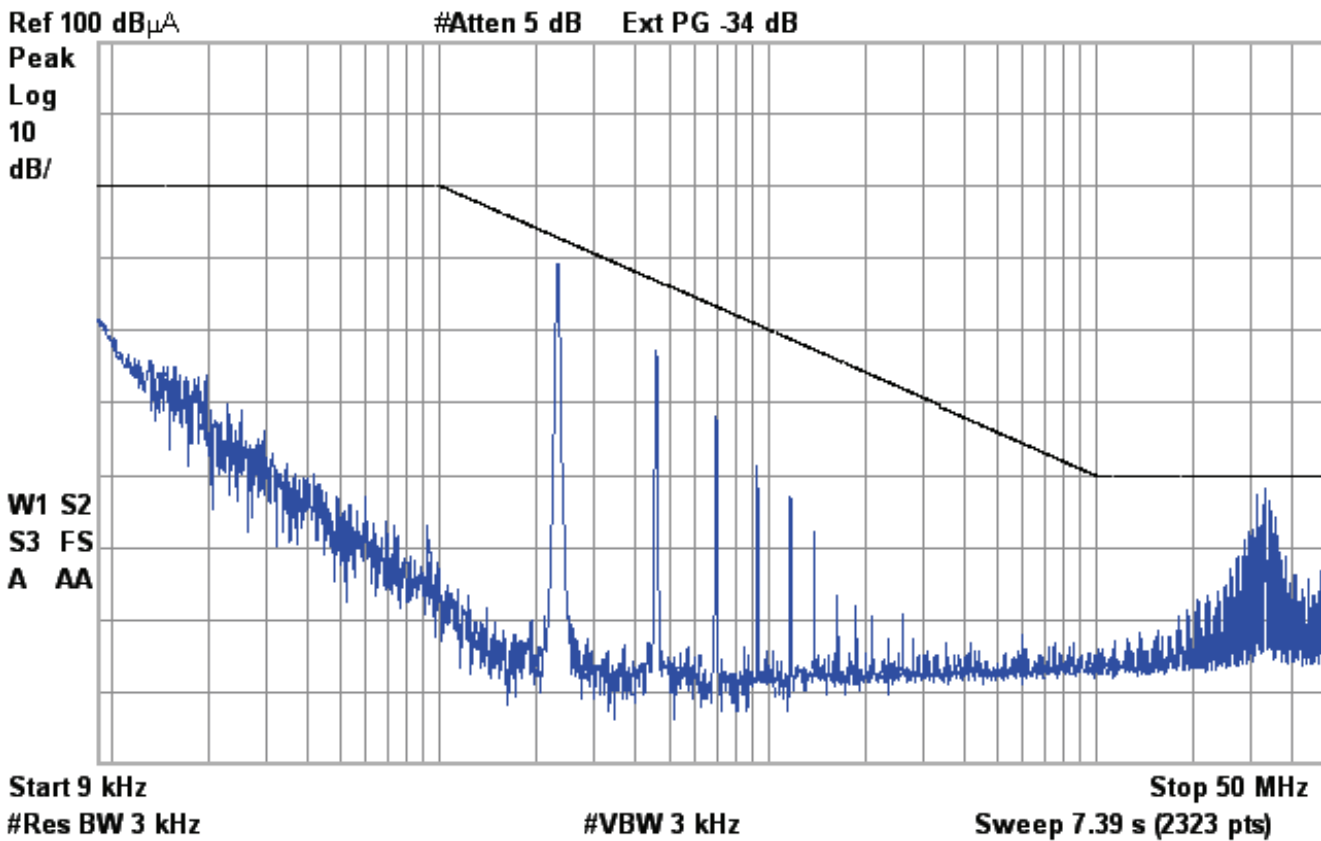
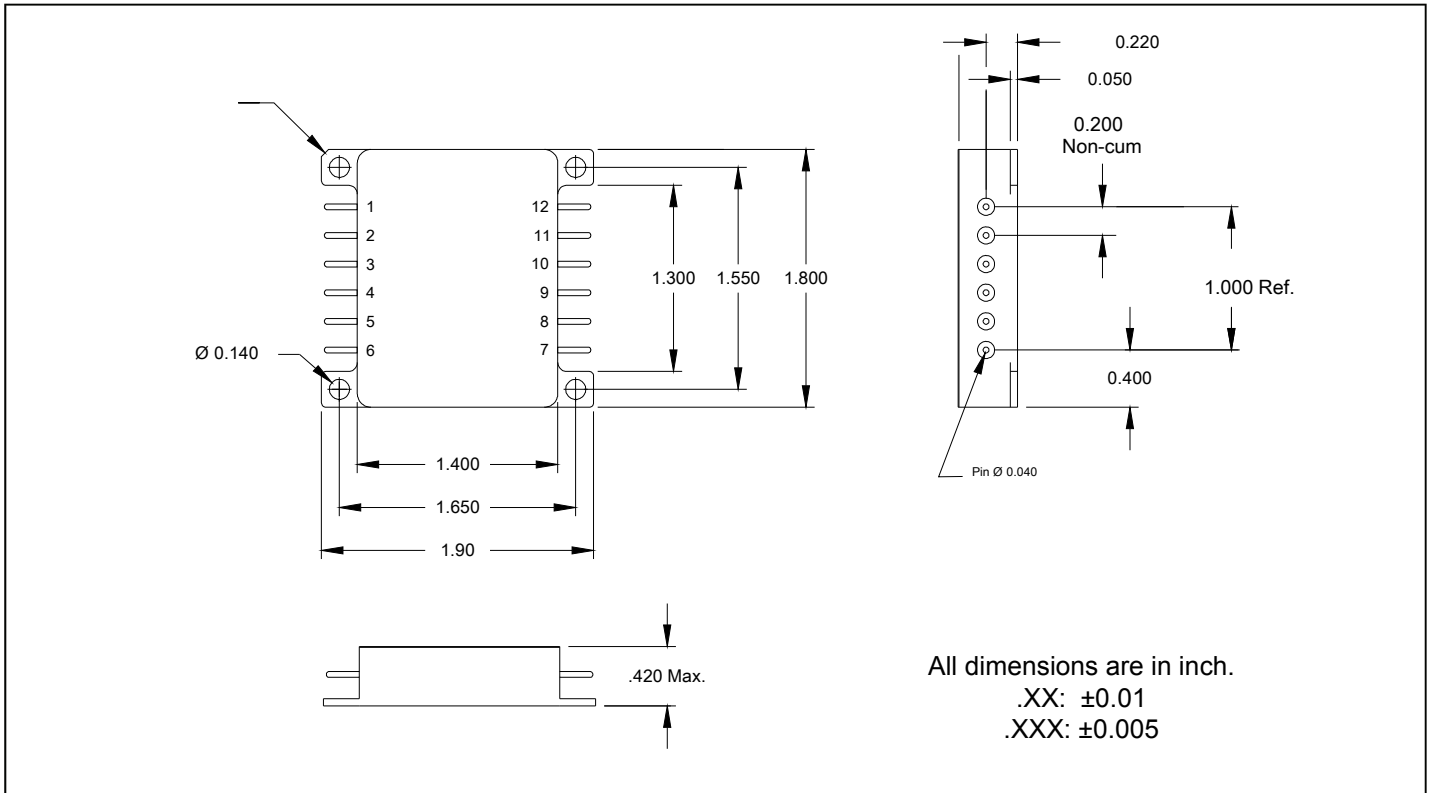


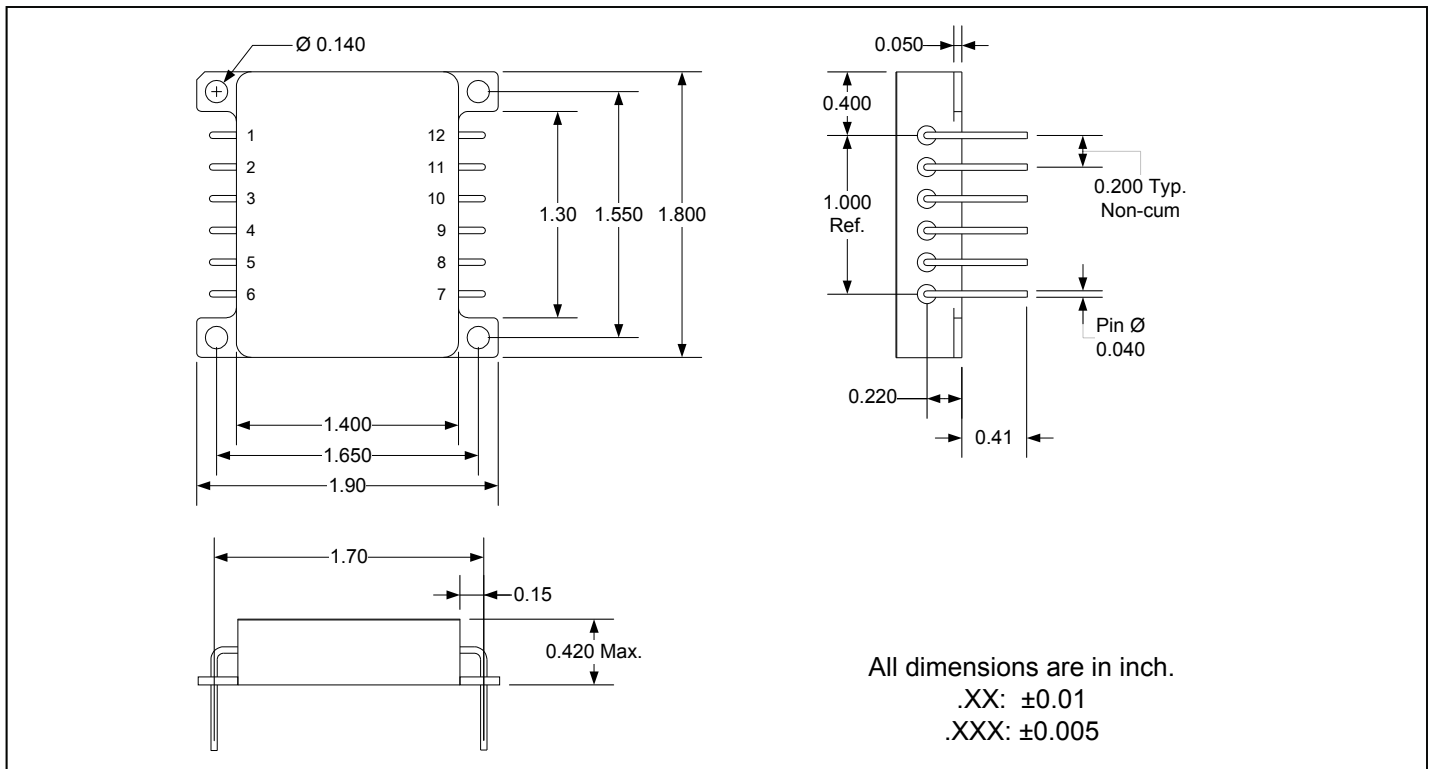
Fig. 2 - A Typical input EMI Conducted Emission Performance



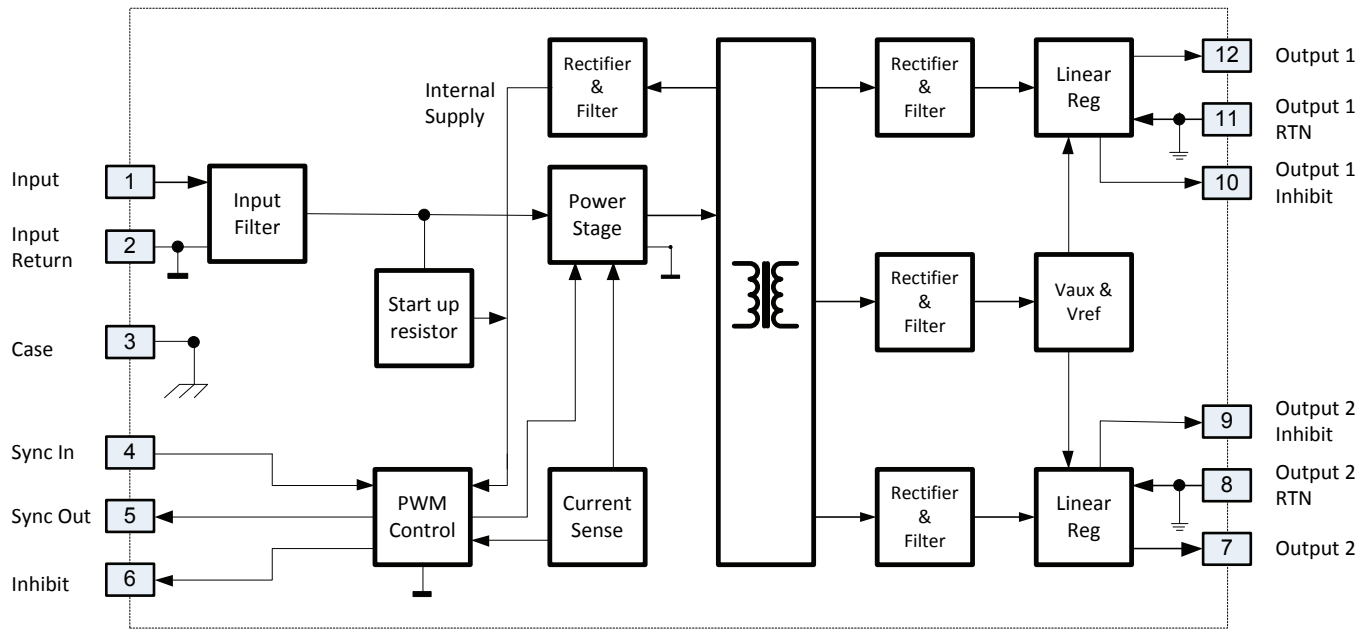
Mechanical Outline - Option A (Straight Pins)



Mechanical Outline - Option B (Down Pins)



Block Diagram

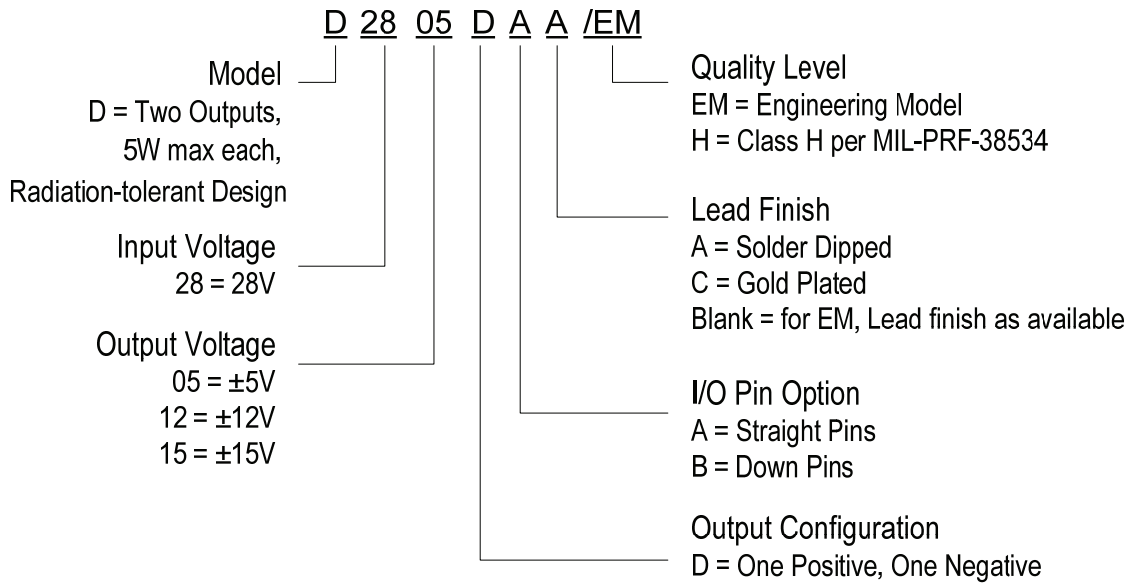


Pin Designation

Pin #	Name
1	Input
2	Input Return
3	Case
4	Sync In
5	Sync Out
6	Inhibit
7	Output 2
8	Output 2 Return
9	Output 2 Inhibit
10	Output 1 Inhibit
11	Output 1 Return
12	Output 1

Note: Pins 9 and 10 are internally connected

Part Numbering



IMPORTANT NOTICE

The information given in this document shall be in no event regarded as guarantee of conditions or characteristic. The data contained herein is a characterization of the component based on internal standards and is intended to demonstrate and provide guidance for typical part performance. It will require further evaluation, qualification and analysis to determine suitability in the application environment to confirm compliance to your system requirements.

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